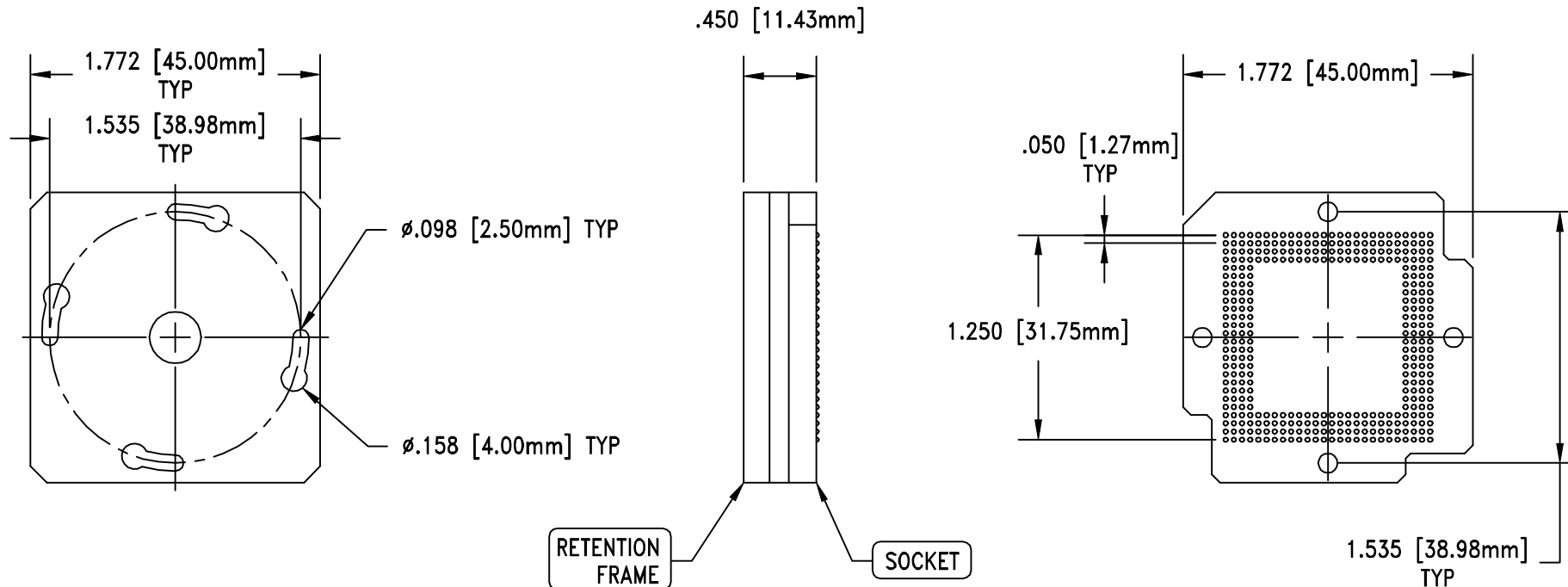


SKT1133

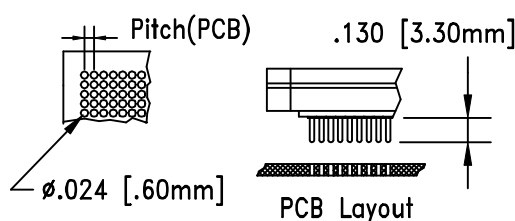
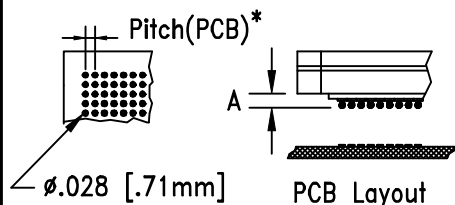
DOD 41133



RECOMMENDED PAD LAYOUT

SMT STYLE  
-29(RC) & -30(SM) TYPE

THRU HOLE STYLE  
-70(ET) TYPE



XX(YY)= SOLDERTAIL STYLE

30= standard SMD ("A" = .047 [1.20mm])  
29= raised SMD ("A" = .197 [5.00mm])

PIN DIAMETER FOR -70(ET)=.018 [.45mm]  
BALL DIAMETER FOR -29(RC) & -30(SM)=.026 [.66mm]

\* The pitch dimension depends on your Ball Grid Array

ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE SPECIFIED



**Emulation Technology, Inc.**

— VLSI and SMT ADAPTERS and ACCESSORIES —

2344 Walsh Avenue, Bldg. F  
Santa Clara, Ca 95051

TEL:(408)982-0660  
FAX:(408)982-0664

SHEET:  
1 OF 1

DATE:  
7-05-00

REVISION:

**ASSEMBLY DRAWING**

CHECKED:  
Paula Olson

DRAWN:  
Miguel Delgadillo

ITEM: S-BGK-26-352-YY

DESCRIPTION:  
BPK-352-2BG026-XX

**DO NOT SCALE DRAWING**